

INTERNATIONAL STANDARD



Universal Serial Bus interfaces for data and power –
Part 4-1: Universal Serial Bus 4™ Specification

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Part 4-1: Universal Serial Bus 4™ Specification

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The text of this International Standard is based on the following documents:

Draft	Report on voting
100/3754/CDV	100/3813/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

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The IEC 62680 series is based on a series of specifications that were originally developed by the USB Implementers Forum (USB-IF). These specifications were submitted to the IEC under the auspices of a special agreement between the IEC and the USB-IF.

This standard is the USB-IF publication, USB4™ Specification, Version 1.0 with Errata and ECN through May 19, 2021.

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1.0 with Errata and ECN through October 15, 2020	Includes errata and ECN through October 15, 2020 as part of the specification text.	October 2020
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